

MDA HT Series
SMD Low Profile High Current Molded Inductor
Size 6045



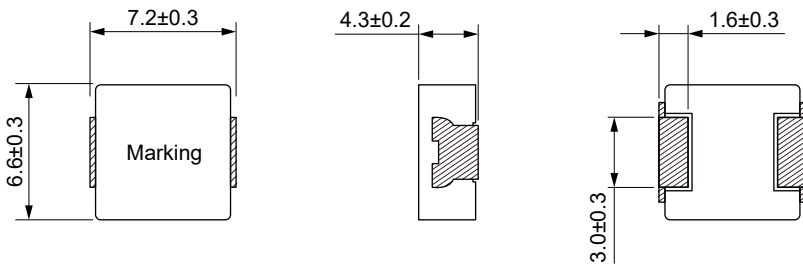
FEATURES

- Low loss realized with low DCR.
- Ultra low buzz noise, due to composite construction .
- 100% Lead(Pb)-Free and RoHS compliant.
- High performance (Isat) realized by metal dust core.
- AEC-Q200 qualified.
- Operating temperature: -55 to +155 °C (including self-temperature rise)
- Quantity: 1000PCS

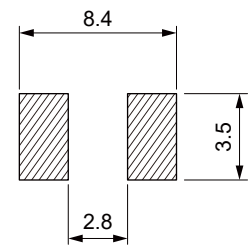
APPLICATION

- Headlamps, tail lamps and interior lighting
- HVAC
- Doors, window lift and seat control
- Audio subsystem
- Digital instrument cluster
- In-Vehicle Infotainment and navigation

Dimensions: [mm]



Land Pattern: [mm]



Electrical Properties:

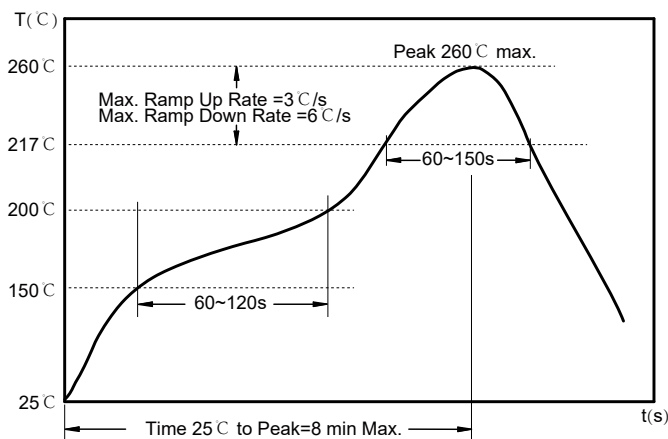
| Part No | Inductance @ 100KHz/1V (μH) | Tolerance | Temperature Rise Current Typ. (A) | Temperature Rise Current Max. (A) | Saturation Current Typ. (A) | Saturation Current Max. (A) | DC Resistance Typ. (mΩ) | DC Resistance Max. (mΩ) | Rated Voltage (V) |
|----------------|-----------------------------|-----------|-----------------------------------|-----------------------------------|-----------------------------|-----------------------------|-------------------------|-------------------------|-------------------|
| MDA6045HT-R22M | 0.22 | ±20% | 22.2 | 20.0 | 57.2 | 49.0 | 2.00 | 2.40 | 70 |
| MDA6045HT-R47M | 0.47 | ±20% | 18.1 | 16.3 | 25.0 | 21.0 | 3.00 | 3.60 | 70 |
| MDA6045HT-1R0M | 1.0 | ±20% | 13.3 | 12.0 | 23.9 | 16.5 | 5.20 | 6.20 | 70 |
| MDA6045HT-1R5M | 1.5 | ±20% | 11.6 | 10.4 | 19.7 | 15.0 | 6.70 | 8.10 | 70 |
| MDA6045HT-2R2M | 2.2 | ±20% | 9.80 | 8.80 | 19.4 | 14.0 | 9.50 | 11.4 | 70 |
| MDA6045HT-3R3M | 3.3 | ±20% | 7.60 | 6.80 | 17.7 | 13.5 | 15.7 | 18.8 | 70 |
| MDA6045HT-4R7M | 4.7 | ±20% | 6.70 | 6.10 | 14.8 | 11.2 | 20.2 | 24.2 | 70 |
| MDA6045HT-6R8M | 6.8 | ±20% | 5.20 | 4.70 | 12.1 | 10.1 | 33.0 | 39.6 | 70 |
| MDA6045HT-8R2M | 8.2 | ±20% | 5.00 | 4.50 | 10.2 | 8.80 | 40.0 | 48.0 | 70 |
| MDA6045HT-100M | 10 | ±20% | 4.30 | 3.90 | 9.60 | 8.20 | 47.9 | 57.5 | 70 |

| Part No | Inductance @ 100KHz/1V (μH) | Tolerance | Temperature Rise Current Typ. (A) | Temperature Rise Current Max. (A) | Saturation Current Typ. (A) | Saturation Current Max. (A) | DC Resistance Typ. (mΩ) | DC Resistance Max. (mΩ) | Rated Voltage (V) |
|----------------|-----------------------------|-----------|-----------------------------------|-----------------------------------|-----------------------------|-----------------------------|-------------------------|-------------------------|-------------------|
| MDA6045HT-150M | 15 | ±20% | 3.70 | 3.40 | 6.20 | 5.30 | 66.0 | 79.2 | 70 |
| MDA6045HT-220M | 22 | ±20% | 3.20 | 2.90 | 5.20 | 4.10 | 86.7 | 104 | 70 |
| MDA6045HT-330M | 33 | ±20% | 2.70 | 2.40 | 4.40 | 3.50 | 121 | 145.2 | 70 |
| MDA6045HT-470M | 47 | ±20% | 2.30 | 2.10 | 4.20 | 3.30 | 195 | 212 | 70 |
| MDA6045HT-680M | 68 | ±20% | 1.80 | 1.60 | 3.90 | 3.00 | 312 | 374 | 70 |
| MDA6045HT-101M | 100 | ±20% | 1.50 | 1.35 | 2.40 | 2.10 | 413 | 496 | 70 |

Saturation Current will cause L to drop approximately 30%

Temperature Rise Current: The actual value of DC current when the temperature rise is $\Delta T=40^{\circ}\text{C}$

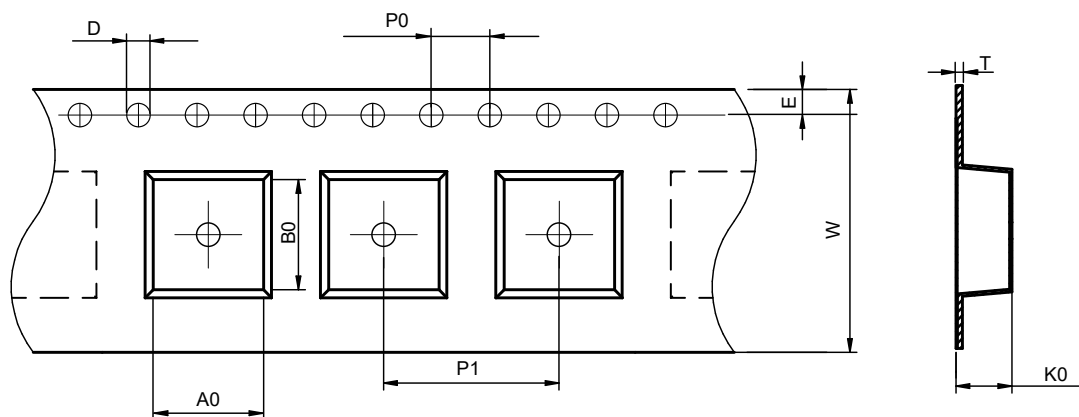
Soldering Reflow:



Preheat condition: 150 ~200°C / 60~120 sec.
 Allowed time above 217°C : 60~150 sec.
 Max temperature: 260°C .
 Max time at max temperature: 10 sec.
 Allowed Reflow time: 2x max.

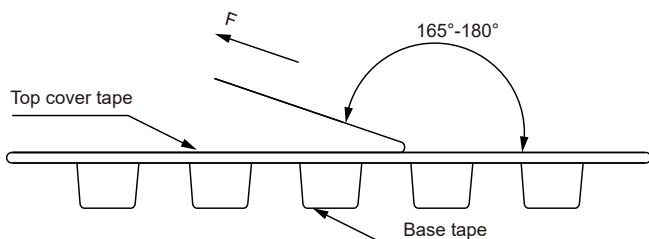
Packaging Information:

Tape Dimension :



| Series | A0 (mm) | B0 (mm) | D (mm) | P0 (mm) | P1 (mm) | W (mm) | K0 (mm) | E (mm) | T (mm) |
|-----------|---------|---------|---------|---------|----------|----------|---------|----------|-----------|
| MDA6045HT | 7.0±0.1 | 7.7±0.1 | 1.5±0.1 | 4.0±0.1 | 12.0±0.1 | 16.0±0.3 | 4.9±0.1 | 1.75±0.1 | 0.40±0.05 |

Peel force of top cover tape:

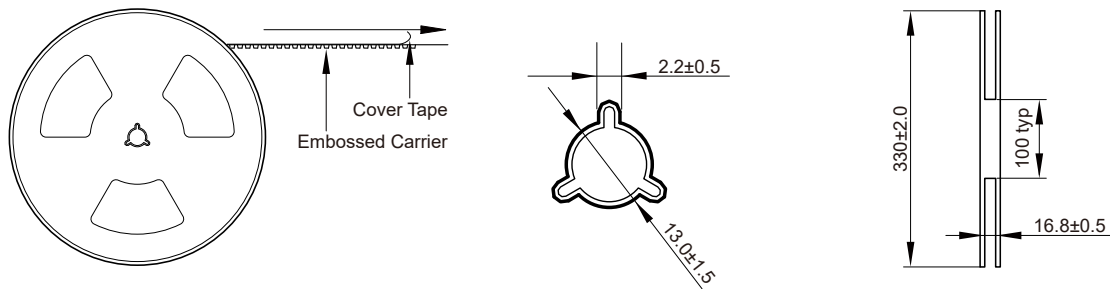


The peel force of top cover tape shall be between 0.1 to 1.3 N

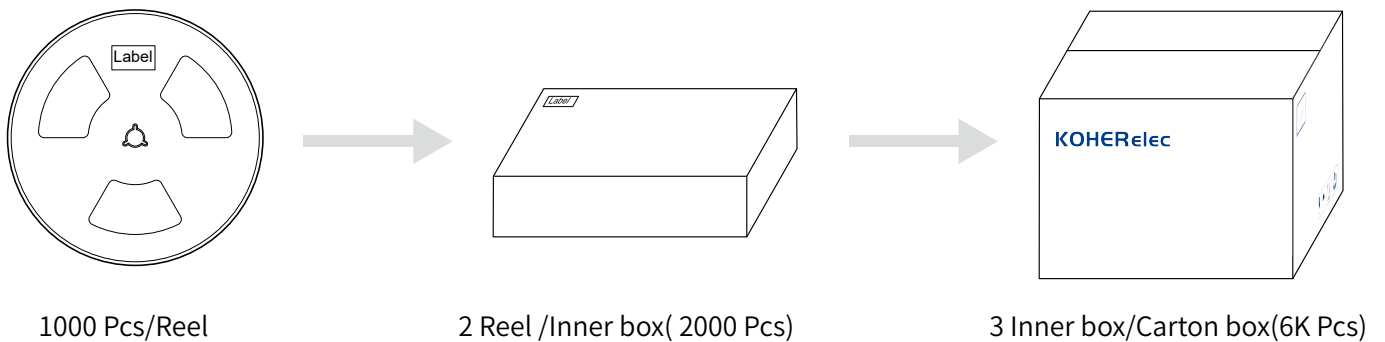
Product Marking:

| | |
|---------|--------------------------------|
| Marking | K+Printing (Inductance+period) |
|---------|--------------------------------|

Reel Dimension: [mm]



Packaging Quantity:



Cautions and Warnings:

Storage Conditions :

- The storage period is within 12 months after the completion of production. Be sure to follow the storage conditions (temperature: -5 to 35°C, humidity: 75% RH Max).If the storage period elapses, the soldering of the terminal electrodes may deteriorate.The warranty period is one year.
- Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and etc.
- Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

Operation Instructions:

- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Before soldering, be sure to preheat components.The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- Generally, Koher might not be familiar with either customer's specific application or actual requests as customer does.As a result customer shall be responsible for checking and confirming whether Koher product with the performance described in the product specification is suitable for using in customer's particular application or not.